

MEGAWATT SCHOLARSHIP APPLICATION

PRESENTED BY



2026 VALGROUP/ONSITE PARTNERS STEM SCHOLARSHIP

Founded in 1976 in Lorena/Sao Paulo, Valgroup is a Brazilian company specializing in developing, manufacturing, and marketing flexible packaging in polyethylene. With over 30 years in the market, Valgroup is considered one of the largest and most efficient organizations in the segment. Valgroup Findlay Operations has partnered with OnSite Partners to continue its efforts to live its value of social and environmental responsibility by harnessing wind energy for production power. To fulfill the social aspect of this value, the company is offering two Valgroup/OnSite Partners STEM Scholarships. Each scholarship is a one-time award in the amount of \$5,000.

APPLICATION DEADLINE: April 11, 2026

Submit application to: Megawatt Scholarships
12385 Township Road 215
Findlay, OH 45840

ELIGIBILITY

Student must be a senior for the 2025-2026 academic school year, reside in Hancock County, and attend an accredited school. To be considered, the student must have demonstrated academic excellence in high school and have plans to complete a science, technology, engineering, or math degree in an accredited school. All criteria are not absolute.

SELECTION OF RECIPIENTS

Selection will be based on achievement and academic record during high school, submitted essay, and community activities. Leadership experience is preferred, but not a requirement.

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I. PERSONAL INFORMATION

Student Name	Date of Birth	Telephone
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E-Mail Address _____

Permanent Home Address	City	State	Postal Code
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Do you have a parent or relative working at the Valgroup Findlay Plant?

Yes **No**

If so, provide name _____

II. ACADEMIC RECORD

Grade Point Average	Grade Point Scale	High School Graduation Date
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III. CAREER PLANS

State the college(s) you plan to attend and briefly describe your career plans upon graduation.

IV. ESSAY

Please attach a **typed** essay between 500-1,500 words regarding the following topic:

Discuss where you see your STEM career leading you, and what your environmental responsibility as a professional is.

The essay must be original and sole work of the applicant.

V. PLEASE ATTACH AN OFFICIAL HIGH SCHOOL TRANSCRIPT

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Name: _____

Please list activities, including school organizations and clubs, athletics, community or service organizations, work experience, and major awards and honors for the past three academic years.

School Organizations and Clubs	Contributions, Accomplishments, Positions Held, and Honors

Athletics	Contributions, Accomplishments, Positions Held, and Honors

MEGAWATT SCHOLARSHIP APPLICATION

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Community or Service Organizations	Contributions, Accomplishments, Positions Held, and Honors

Work Experience	Dates of Employment	Hours per Week	Position Held, Accomplishments

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Major Awards and Honors	School Year(s)

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By accepting the award, the recipient agrees that Valgroup, OnSite Partners, and their respective affiliates and subsidiaries may use any photographs and/or video of the recipient, and use the recipient's name and likeness with respect to their participation in the scholarship program in publications, news releases, online and other digital publications, and all publications and communications, regardless of media, related to the scholarship program and/or the mission of OnSite Partners.

Signature of Applicant: _____ **Date:** _____

If the applicant is under the age of 18, the undersigned gives permission for the applicant to participate in the scholarship program and agrees to the program's eligibility criteria on behalf of the applicant, and represents that the undersigned has the authority to grant such permission and agreement on behalf of the applicant:

Signature: _____ **Date:** _____

Printed Name: _____